



PRODUCT SPECIFICATION

(產品規格書)

Ordering information

4977-	PIN	-M	-5K	-Tx
Series	PIN	M: Male	5K Pins Per Reel	T1/T4: Wire Range 18~22 AWG T2/T5: Wire Range 16~20 AWG
		F: Female		T1: Wire Range 18~22 AWG T2: Wire Range 16~20 AWG

4977-	PIN	-M	-2.5K	-Tx
Series	PIN	M: Male	2.5K Pins Per Reel	T3/T6: Wire Range 12~14 AWG
		F: Female		T3: Wire Range 12~14 AWG

A1:JUL.17/2012.
A2:MAY.14/2013.(變更滿捲數量)

PRODUCT NAME (產品名稱)	DOCUMENT No.: (文件編號)	Rev. (版本)	OUPIIN
6.35mm Wafer Terminal (RoHS)	4977spec-PIN	A2	(歐品)
	Approved (核準)	Checked (審核)	Prepared (製作)
	Q.A. Section Chief	Amy Chiu	MAY.14/2013



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1. SCOPE (範圍)

This product specification defines the product performance and the test methods to ascertain the performance of the 6.35mm Wafer (Terminal), which is designed and manufactured by Oupiin Electronic Co.,Ltd.

(本產品規格書規定了由歐品電子有限公司生產的 6.35mm Wafer (Terminal), 型連接器,產品的特性及測試方法.)

2. REFERENCE DOCUMENTS (參考文件)

MIL-STD-1344A	Test method for electrical connector (電子連接器測試方法)
MIL-STD-202F	Test method for electrical components (電子零件測試方法)

3. FEATURE & DIMENSIONS (特徵及尺寸)

3.1. PRODUCT DIMENSION (產品尺寸)

These connectors shall have the dimensions as shown in drawing.
(本產品的相關尺寸參考圖面.)

3.2. PCB/PANEL LAYOUT (印刷電路板佈局)

The recommended PCB layout is shown in drawing.
(本產品適用的 PCB layout 參考圖面.)

3.3. BILL OF MATERIAL (材料清單)

Harmful material control follow the requirement of RoHS. The bill of material and product number is described in drawing.
(有害物質控制符合RoHS指令要求.本產品使用的材料參考附件.)

3.4. MECHANICAL & ELECTRICAL CHARACTERISTIC (機械及電氣特性)

The connector shall have the mechanical and electrical performance as described in drawing.
(本產品的機械及電氣特性見圖面：)

3.5. PACKAGING (包裝)

Products shall be packaged according to requirements specified in purchase order for safe delivery, connector container and the packaging method are shown in package specification.
(產品可依客戶指定要求包裝，包裝材料與包裝方式參見產品包裝規範。)



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3.6 RATING CURRENT AND RATING VOLTAGE 額定電流與額定電壓

Rating current is 10 A, rating voltage is 600V DC/AC RMS.

額定電流 10A，額定電壓 600V DC/AC RMS。

3.7 OPERATING TEMPERATURE 使用溫度

Temperature range: -55°C~+105°C。

溫度範圍：-55°C~+105°C。

4. ENVIRONMENTAL (環境要求)

4.1. SOLDERABILITY (可焊性)

Connectors meet solder ability to MIL-STD-202F. Finish shall be free of contaminants.

(產品可焊性符合 MIL-STD-202F 標準規定的相關要求，表面不得有污染物.)

4.2. RESISTANCE TO SOLDER HEAT (耐焊接熱)

WAVE SOLDERING (波峰接)

Each cycle consists of three consecutive phases.

(每個焊接週期包括三個連續的階段)

1. Preheat (預熱)

The steady temperature of the preheat zone is 90~125°C.

(預熱區最終溫度控制在90~125°C)

2. Soldering (焊接)

To avoid the secondary tin-melting, the temperature on PCB upper surface is 160°C Max. for products with lead, or 200°C Max. for lead-free products. The temperature of the PCB bottom surface shall not be exceed 100°C more than the temperature of the PCB upper surface. The peak temperature is during 220~230°C for products with lead, or 230~245°C for lead-free products. The tin dip time is duration for 3~5 seconds.

(有鉛產品板面溫度不得超過160°C，無鉛產品板面溫度不得超過200°C，以防止貼片零件二次熔錫。板面溫度與板底的溫度溫差不得超過100°C。板下溫度峰值有鉛產品維持在220~230°C，無鉛產品控制在230~245°C。浸錫時間控制在3~5秒。)

3. Cool Down (冷卻)

Cool down shall not exceed 6°C per second.

(冷卻速度不超過6°C/秒.)

Note: (說明)

Device temperature measurements are referenced from the top-center of the package outer surface.

(設備溫度量測時以從頂部中間位置測量為準.)



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5. PERFORMANCE AND TEST DESCRIPTION

(性能及測試)

5.1. REQUIREMENT (要求)

Product is designed to meet electrical, mechanical, and environmental performance requirements specified in **Table I**.

(本產品設計符合附表一所述的機械，電氣及環境要求。)

5.2. TEST CONDITION (測試條件)

Unless otherwise specified, all tests shall be performed at ambient environmental conditions.

(除非特別注明，所有測試在室溫條件下完成；)

5.3. SAMPLE SELECTION (樣品選擇)

Test samples shall be selected at random from current production. No test samples shall be reused. Samples are pre-conditioned with 10cycles of durability. Each group shall be containing 5 test samples.

(測試樣品從現生產的產品中隨機抽取，所有測試過的樣品不得重複使用。樣品已預先插拔10次，每組測試有5個樣品；)

Table I: Test Requirements and Procedures

(附錄一:測試要求)

Items (項目)	Requirements (要求)	Test Methods (檢測方法)
1. Confirmation of Product (產品確認)	Product shall be conforming to the requirements of applicable product drawing. (產品必須滿足相關檔的規定)	Check the dimensions and functions per applicable product drawing in your eyes. (目視，尺寸及功能依產品圖面檢查)
2. Dielectric Strength (耐電壓)	Connector must withstand test potential of 600 V AC for 1 minute. Current leakage must be 0.5 m A max. (樣品必須承受測試電壓 600V AC，時間一分鐘，漏電流不大於 0.5 mA.)	Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector. MIL-STD-202, Method 301. (測試產品端子間以及端子與接地間的電壓，適用：MIL-STD-202，方法 301。)
3. Solder ability (可焊性)	Appearance of the specimen shall be inspected after the test with the assistance of a magnifier capable of giving a magnification of 10 X for any damage such as pinholes, void or rough surface. (樣品在測試完成後，在放大倍數為 10 倍的顯微鏡下，檢查外觀損壞如：小孔，空焊，外觀粗糙度；)	Soldering time: 3 to 5 Seconds (焊接時間：3~5 秒) Soldering Temperature: 245±5°C. (焊接溫度：245±5°C.)



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Material Contact : Copper Alloy (Brass)

[SGS Test Report Click here](#)

[如需 SGS 測試報告請點選此處](#)



REPORT OF MATERIAL TEST

MILL CERTIFICATE

DATE: FEB. 11, 2009

Customer: 歐品電子有限公司

Commodity: C 2680 R BRASS STRIP (H)

ISO 9002:4M8Y035-00
台正字第 3544 號

Applied Standard: CNS 4383 Brass Sheets, Plates and Strips

Chemical Analysis Test

Work No.	Size of Product			Cu(%)	Fe(%)	Pb(%)	Zn(%)			
	Thickness (mm)	Width (mm)	Length (mm)							
	Standard									
				64.00 - 68.00	max. 0.050	max. 0.014	REM.			
81A414A	0.400	305.000		65.816	0.009	0.006	REM.			

Mechanical & Physical Test

Work No.	Size of Product			Dimension Test		Tension Test		Hardness Test HV	Grain Size (mm)	Electric Conductivity (%)
	Thickness (mm)	Width (mm)	Length (mm)	Thickness (mm)	Width (mm)	Tensile Strength (kgf/mm ²)	Elongation (%)			
	Standard			-	(-) 0.10 - (+) 0.00	42 - 55	-			
81A414A	0.400	305.000		GOOD.	GOOD.	49.89	17.36	150.0 - 152.0	-	25.4

QC Supervisor

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